CLAIMS

	1.	A device [110], comprising:
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		a housing [155] having a first side [160] and an opposing second side [165],
4		wherein the housing [155] comprises:
6		an opening [170] extending from the first side [160] to the second side
		[165]; and
8		multiple alignment pins [180] imbedded in the housing [155] and
10		extending external to both first and second sides [160,165], wherein on
10		the first side [160] the alignment pins [180] are capable of insertion into
12		matching holes on an electronic probe [130], and wherein on the second
		side [165] the alignment pins [180] are capable of insertion into matching
14		holes [185] on an electronic circuit assembly [120].
		2. The device [110] as recited in claim 1, further comprising at least one
2		fastener part [196] capable of attaching the electronic probe [130] to the
		housing [155].
		3. The device [110] as recited in claim 2, wherein the fastener part [196]
2		comprises a threaded screw hole [196] into which a screw [135] attached
		to the electronic probe [130] can be inserted.
		4. The device [110] as recited in claim 1, wherein the at least one fastener
2		part [196] comprises two fastener parts [196].
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		5. The device [110] as recited in claim 4, wherein the fastener parts [196]
2		each comprise a threaded screw hole [196] into which a screw [135]

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attached to the electronic probe [130] can be inserted.

- 6. The device [110] as recited in claim 1, wherein the axis of each alignment pin [180] is parallel to the axis of the opening [170].
 - 7. The device [110] as recited in claim 1, wherein on the second side [165] the alignment pins [180] are capable of attachment to the electronic circuit assembly [120] following their insertion into the electronic circuit assembly [120] matching holes [185].
- 8. The device [110] as recited in claim 7, wherein attachment of the alignment pins [180] to the electronic circuit assembly [120] is effected by soldering the alignment pins [180] into the electronic circuit assembly [120] matching holes [185].
 - 9. The device [110] as recited in claim 1, wherein the electronic circuit assembly [120] is a printed circuit board [120].
 - 10. The device [110] as recited in claim 1, wherein the multiple alignment pins [180] comprise four alignment pins [180].
 - 11. The device [110] as recited in claim 1, further comprising:
- a first key [175], wherein when the first key [175] is aligned with a matching geometry on the electronic probe [130], entry of the electronic probe [130] into the opening [170] is enabled, otherwise entry is prevented.
 - 12. The device [110] as recited in claim 1, further comprising:

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	a second key [190], wherein when the second key [190] is aligned with a
4	matching geometry [195] on the electronic circuit assembly [120],
	attachment of the device [110] to the electronic circuit assembly [120] is
6	enabled, otherwise such entry is prevented.

- 13. The device [110] as recited in claim 12, wherein the second key [190] is an additional pin [190] imbedded in the housing [155] and extending external to the second side [165] and wherein the matching geometry [195] on the electronic circuit assembly [120] is a hole [195] into which the additional pin [190] is capable of insertion.
- 14. The device [110] as recited in claim 12, further comprising:

a first key [175], wherein when the first key [175] is aligned with a matching geometry on the electronic probe [130], entry of the electronic probe [130] into the opening [170] is enabled, otherwise entry is prevented.

- 15. The device [110] as recited in claim 14, further comprising at least one fastener part [196] capable of attaching the electronic probe [130] to the housing [155].
- 16. The device [110] as recited in claim 15, wherein the fastener part [196] comprises a threaded screw hole [196] into which a screw [135] attached to the electronic probe [130] can be inserted.
- 17. The device [110] as recited in claim 14, wherein on the second side [165]
 the alignment pins [180] are capable of attachment to the electronic circuit assembly [120] following their insertion into the electronic circuit assembly [120] matching holes [185].

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- The device [110] as recited in claim 17, wherein attachment of the alignment pins [180] to the electronic circuit assembly [120] is effected by soldering the alignment pins [180] into the electronic circuit assembly [120] matching holes [185].
 - 19. The device [110] as recited in claim 14, wherein the electronic circuit assembly [120] is a printed circuit board [120].
- The device [110] as recited in claim 14, wherein the multiple alignment pins [180] comprise four alignment pins [180].